





ST5 SERIES

ULTRA FINE PITCH HEADER

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?ST5

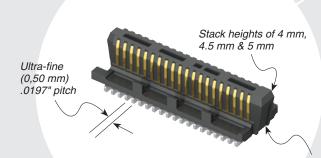
Insulator Material:
Black LCP
Contact Material:
Phosphor Bronze
Plating:
Au or Sn over
50 μ' (1,27 μm) Ni
Operating Temp Range:
-55°C to +125°C
Current Rating:
1.5 A per pin
(1 pin powered per row)
RoHS Compliant:

Processing: Lead-Free Solderable:

Yes SMT Lead Coplanarity: (0,10 mm) .004" max

Mates with:

SS5



SS5/ST5 5 mm Stack Height	Rated @ 3dB Insertion Loss*
Single-Ended Signaling	13.5 GHz / 27 Gbps
Differential Pair Signaling	20 GHz / 40 Gbps

*Test board losses de-embedded from performance data. Performance data for other stack heights and complete test data available at www.samtec.com?ST5 or contact sig@samtec.com 28**+**

Narrow body design saves space on board

ALSO AVAILABLE (MOQ Required)

• Other lead styles Contact Samtec.



MATED HEIGHT*				
ST5	SS5 LEAD STYLE			
LEAD STYLE	-3.00	-3.50		
-1.00	(4,00) .157	(4,50) .177		
-1.50	(4,50) .177	(5,00) .197		
*Processing conditions will affect				

*Processing conditions will affect mated height.

No. of positions — per row x — (0,50) .0197 + (1,40) .055 + (1,40) .055 + (1,46) .0197 + (1,50) .0197

<u>↓</u> B	
(0,20) .008	

(1,46) .057
e¶*
(4,00) .157

LEAD STYLE	Α	В
-1.00	(1,00) .039	(3,08) .121
-1.50	(1,50) .059	(3,58) .141

Note: Some lengths, styles and options are non-standard, non-returnable.